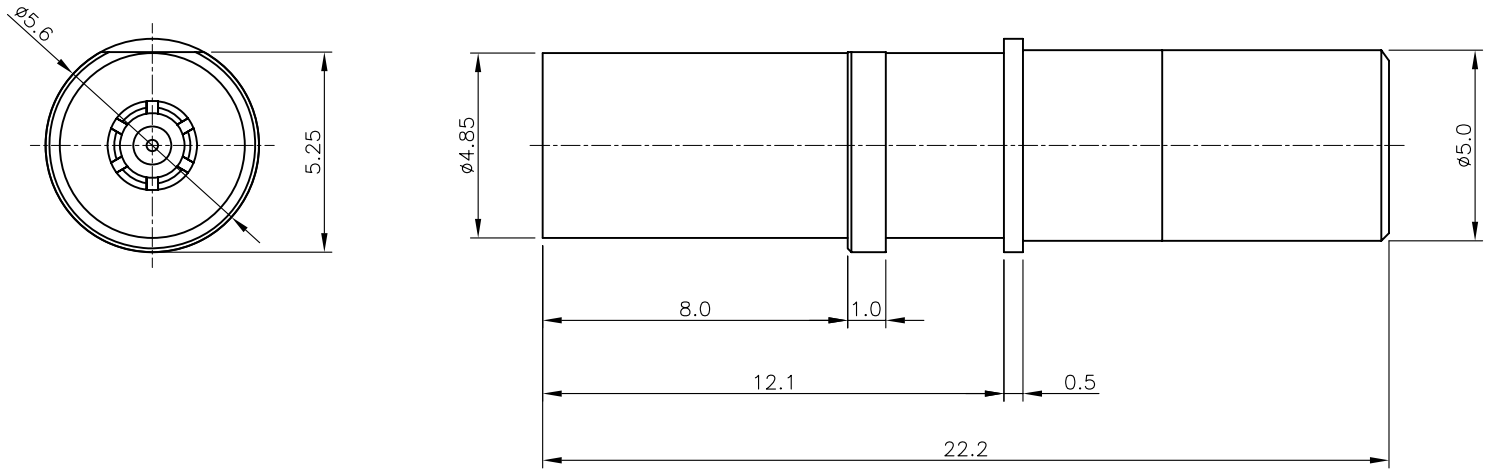
REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	E.H.KIM	I.C.KIM	2013.04.11.



NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE
6	SPRING RING	1	SUS303	Passivated	DSR01111-5/1
5	CAP	1	MBsBD	Gold Plate	DCU02206-5/1
4	JACK	1	BeCu	Gold Plate	DJA00171-5/1
3	INSULATOR	1	TEFLON	White	DIN02164-N/1
2	CONTACT	1	MBsBD	Gold Plate	DAC00246-5/1
1	BODY	1	MBsBD	Gold Plate	DAD00247-5/1

TOLERANCE	Decimal ±0.1	DATE	2013. 04. 11.
	Angle ±1°	APPROVED BY	I.C.KIM
		CHECKED BY	
MATERIAL	-	DRAWN BY	E.H.KIM
FINISH	-	SCALE 5/1	UNIT mm

KJ COMTECH
KJ COMTECH CO.,LTD.
RF & MICROWAVE TECHNOLOGY
Tel : 82-32-347-8015
Fax : 82-32-347-8017

TITLE
26PKZ50 (P) SSMB50 trans(Ø2.75) (P)

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